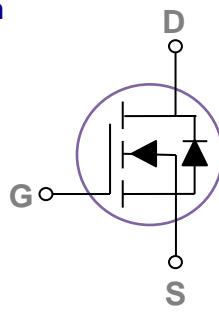
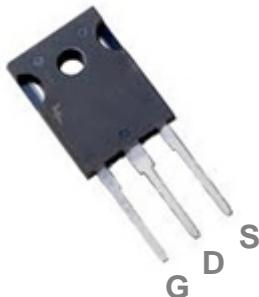


### General Description

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

### TO247 Pin Configuration



BVDSS	RDS(ON)	ID
100V	3.5mΩ	210A

### Features

- 100V, 210A, RDS(ON) = 3.5mΩ@VGS = 10V
- Improved dv/dt capability
- Fast switching
- 100% EAS Guaranteed
- Green Device Available

### Applications

- Networking
- Load Switch
- LED applications
- Quick Charger

### Absolute Maximum Ratings $T_c=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Rating	Units
V <sub>Ds</sub>	Drain-Source Voltage	100	V
V <sub>Gs</sub>	Gate-Source Voltage	±20	V
I <sub>D</sub>	Drain Current – Continuous ( $T_c=25^\circ\text{C}$ )	210	A
	Drain Current – Continuous ( $T_c=100^\circ\text{C}$ )	132	A
I <sub>DM</sub>	Drain Current – Pulsed <sup>1</sup>	840	A
EAS	Single Pulse Avalanche Energy <sup>2</sup>	280	mJ
I <sub>AS</sub>	Single Pulse Avalanche Current <sup>2</sup>	75	A
P <sub>D</sub>	Power Dissipation ( $T_c=25^\circ\text{C}$ )	540	W
	Power Dissipation – Derate above 25°C	4.35	W/°C
T <sub>STG</sub>	Storage Temperature Range	-50 to 150	°C
T <sub>J</sub>	Operating Junction Temperature Range	-50 to 150	°C

### Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
R <sub>θJA</sub>	Thermal Resistance Junction to ambient	---	62	°C/W
R <sub>θJC</sub>	Thermal Resistance Junction to Case	---	0.23	°C/W

**Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)**
**Off Characteristics**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ , $I_{\text{D}}=250\mu\text{A}$	100	---	---	V
$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	$\text{BV}_{\text{DSS}}$ Temperature Coefficient	Reference to $25^\circ\text{C}$ , $I_{\text{D}}=1\text{mA}$	---	0.05	---	$\text{V}/^\circ\text{C}$
$I_{\text{DS}}^{\text{SS}}$	Drain-Source Leakage Current	$V_{\text{DS}}=100\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=25^\circ\text{C}$	---	---	1	$\mu\text{A}$
		$V_{\text{DS}}=80\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=125^\circ\text{C}$	---	---	10	$\mu\text{A}$
$I_{\text{GS}}$	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$ , $V_{\text{DS}}=0\text{V}$	---	---	$\pm 100$	nA

**On Characteristics**

$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{\text{GS}}=10\text{V}$ , $I_{\text{D}}=20\text{A}$	---	2.8	3.5	$\text{m}\Omega$
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}$ , $I_{\text{D}}=250\mu\text{A}$	1.5	2.5	3.5	V
$\Delta V_{\text{GS(th)}}$	$V_{\text{GS(th)}}$ Temperature Coefficient		---	-5	---	$\text{mV}/^\circ\text{C}$
$g_{\text{fs}}$	Forward Transconductance	$V_{\text{DS}}=10\text{V}$ , $I_{\text{D}}=3\text{A}$	---	15	---	S

**Dynamic and switching Characteristics**

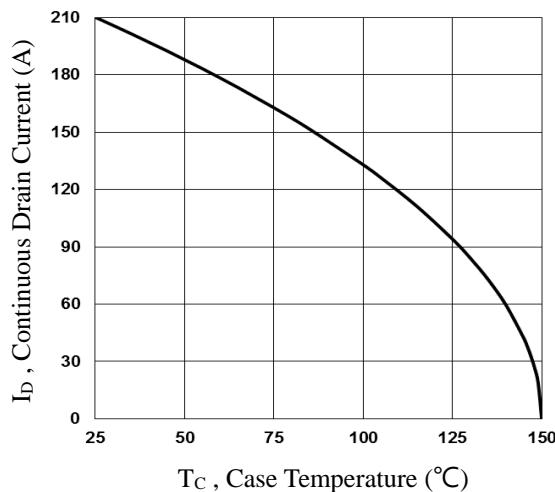
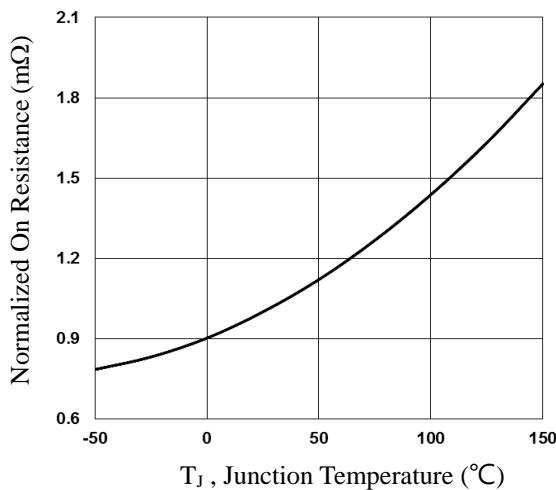
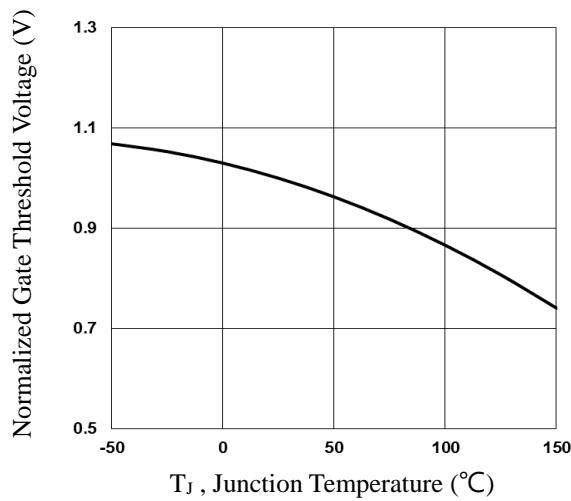
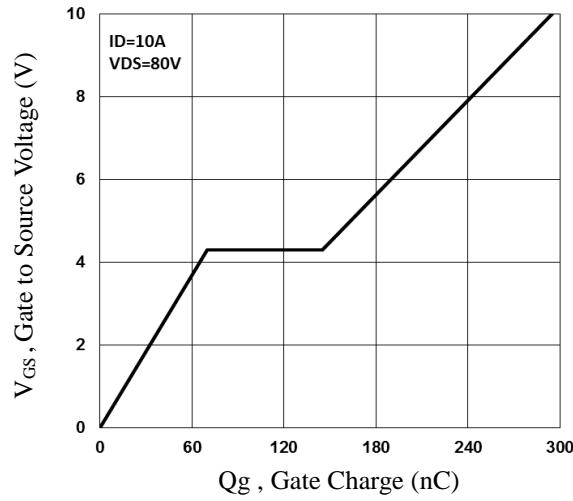
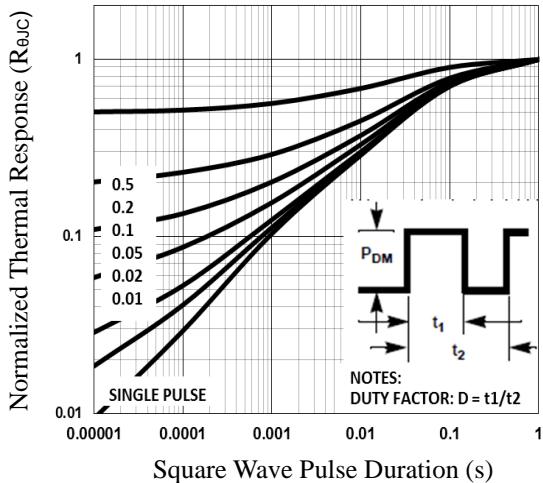
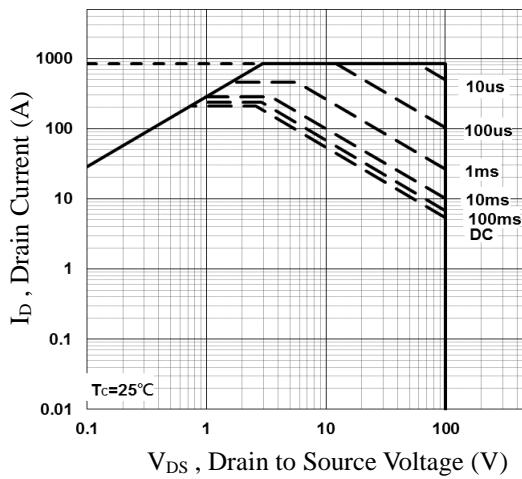
$Q_g$	Total Gate Charge <sup>3, 4</sup>	$V_{\text{DS}}=80\text{V}$ , $V_{\text{GS}}=10\text{V}$ , $I_{\text{D}}=10\text{A}$	---	295	450	nC
$Q_{\text{gs}}$	Gate-Source Charge <sup>3, 4</sup>		---	70	140	
$Q_{\text{gd}}$	Gate-Drain Charge <sup>3, 4</sup>		---	75	150	
$T_{\text{d(on)}}$	Turn-On Delay Time <sup>3, 4</sup>	$V_{\text{DD}}=50\text{V}$ , $V_{\text{GS}}=10\text{V}$ , $R_{\text{G}}=6\Omega$ $I_{\text{D}}=1\text{A}$	---	66.2	120	ns
$T_r$	Rise Time <sup>3, 4</sup>		---	79.6	160	
$T_{\text{d(off)}}$	Turn-Off Delay Time <sup>3, 4</sup>		---	242	480	
$T_f$	Fall Time <sup>3, 4</sup>		---	103	200	
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=25\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $F=1\text{MHz}$	---	17800	26000	pF
$C_{\text{oss}}$	Output Capacitance		---	980	1900	
$C_{\text{rss}}$	Reverse Transfer Capacitance		---	78	150	
$R_g$	Gate resistance	$V_{\text{GS}}=0\text{V}$ , $V_{\text{DS}}=0\text{V}$ , $F=1\text{MHz}$	---	1.8	3.6	$\Omega$

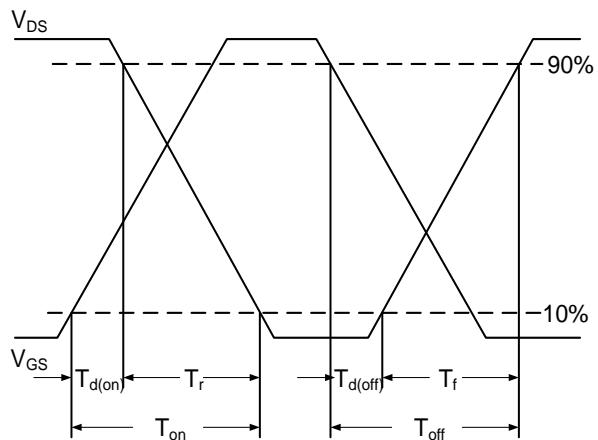
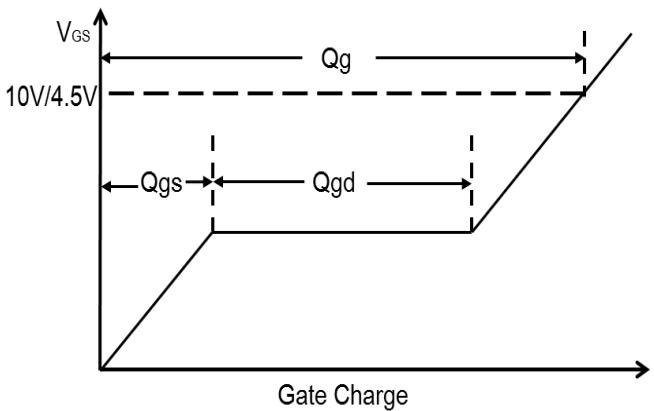
**Drain-Source Diode Characteristics and Maximum Ratings**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_s$	Continuous Source Current	$V_G=V_D=0\text{V}$ , Force Current	---	---	210	A
$I_{\text{SM}}$	Pulsed Source Current		---	---	420	A
$V_{\text{SD}}$	Diode Forward Voltage	$V_{\text{GS}}=0\text{V}$ , $I_s=1\text{A}$ , $T_J=25^\circ\text{C}$	---	---	1	V
$t_{\text{rr}}$	Reverse Recovery Time	$V_{\text{GS}}=0\text{V}$ , $I_s=10\text{A}$ ,	---	64	---	ns
$Q_{\text{rr}}$	Reverse Recovery Charge	$dI/dt=100\text{A}/\mu\text{s}$ , $T_J=25^\circ\text{C}$	---	150	---	nC

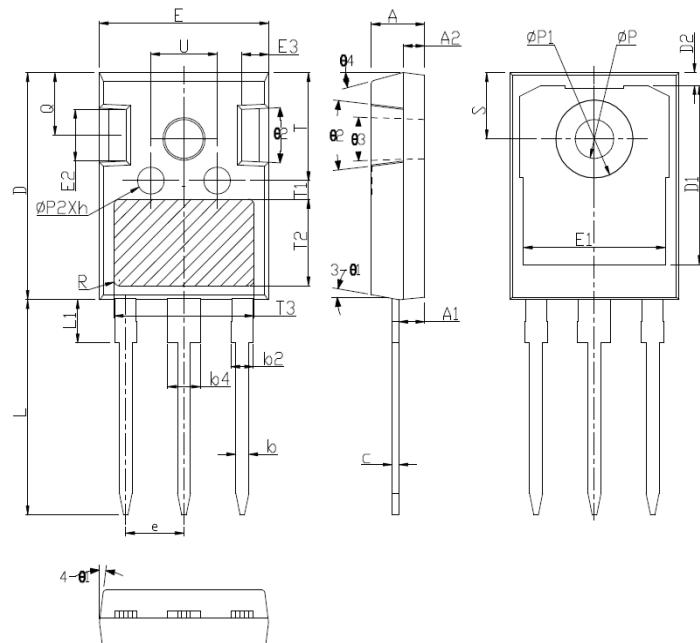
Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2.  $V_{\text{DD}}=50\text{V}$ ,  $V_{\text{GS}}=10\text{V}$ ,  $L=0.1\text{mH}$ ,  $I_{\text{AS}}=75\text{A}$ ,  $R_{\text{G}}=25\Omega$ , Starting  $T_J=25^\circ\text{C}$ .
3. The data tested by pulsed , pulse width  $\leq 300\text{us}$  , duty cycle  $\leq 2\%$ .
4. Essentially independent of operating temperature.


**Fig.1 Continuous Drain Current vs. TC**

**Fig.2 Normalized RDSON vs. TJ**

**Fig.3 Normalized Vth vs. TJ**

**Fig.4 Gate Charge Characteristics**

**Fig.5 Normalized Transient Impedance**

**Fig.6 Maximum Safe Operation Area**


**Fig.7 Switching Time Waveform**

**Fig.8 Gate Charge Waveform**

## TO247 PACKAGE INFORMATION



Symbol	Dimensions In Millimeters			Symbol	Dimensions In Millimeters		
	Min	Nom	Max		Min	Nom	Max
A	4.750	5.000	5.250	L	19.520	19.920	20.320
A1	2.160	2.410	2.660	L1	---	---	4.300
A2	1.850	2.000	2.150	ΦP	3.350	3.600	3.850
b	1.110	1.200	1.350	ΦP1	---	---	7.300
b2	1.900	2.010	2.250	ΦP2	2.250	2.500	2.750
b4	2.900	3.100	3.250	Q	5.500	5.800	6.100
c	0.510	0.610	0.750	S	6.15BSC		
D	20.600	21.000	21.400	R	0.50REF		
D1	16.150	16.550	16.950	T	9.700	---	10.300
D2	1.000	1.200	1.400	T1	1.65REF		
E	15.500	15.800	16.100	T2	8.00REF		
E1	13.000	13.300	13.600	T3	12.80REF		
E2	4.700	5.000	5.300	U	5.900	---	6.500
E3	2.250	2.500	2.750	θ1	3°	7°	10°
e	5.44BSC			θ2	2°	5°	8°
h	0.000	0.100	0.250	θ3	1°	---	2°
				θ4	10°	15°	20°